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Application Number:	10598961
Confirmation Number:	2626
Title of Invention:	METHOD FOR MANUFACTURING SEMICONDUCTOR DEVICE
First Named Inventor:	Tomoyuki Watanabe
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	Doc Desc		Start	Er	nd
	Preliminary Amendment		1	1	
	Specification		2	2	
	Applicant Arguments/Remarks Made in an Amendment		3	3	
Warnings:					
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2	Application Data Sheet	06-09-15_US_ADS_Form_S B_14.pdf	2149051	no	4
Warnings:	-			<u></u>	
Information:					
3		06-09-15_Spec_Claims_Abs tract.pdf	849186	yes	26
		Multipart Descriptio	n		
	Doc Desc Specification Claims Abstract		Start	End	
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			26	26	
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4	Drawings	06-09-15_Drawings.pdf	120830	no	8
Warnings:				<u> </u>	
Information:					
5	Documents submitted with 371 Applications	06-09-15_Published_PCT_A pplication.pdf	1087648	no	26
Warnings:					
Information:					
6	Oath or Declaration filed	06-09-15_Declaration.pdf	150720	no	3

Warnings:					
Information:					
7	Information Disclosure Statement (IDS) Filed	06-09-15_IDS_within_3_mon ths.pdf	69674	no	2
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Information:					
12	Foreign Reference	FR04_JP2004-047624.pdf	2163444	no	33
Warnings:					
Information:	:				
13	Foreign Reference	FR05_JP58-168259.pdf	197938	no	5
Warnings:					
Information:					
14	Foreign Reference	FR06_2000-306992.pdf	467723	no	7
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Warnings:						
Information:						
15	NPL Documents	NPL01_International_Search _Report.pdf	78716	no	2	
Warnings:	Warnings:					
Information:						
16	Fee Worksheet (PTO-875)	fee-info.pdf	8405	no	2	
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National Stage of an International Application under 35 U.S.C. 371

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